DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CONDUCTIVE POLYMER AND SOLID ELECTROLYTIC CAPACITOR USING SAME

the specification of	of which is attached hereto ur	iless the following is check	ced	
	as United States Applicator PCT/JP2004/011676 and			as PCT International
I hereby state that claim(s), as amen	. I have reviewed and underst ded by any amendment refer	and the contents of the above.	ve-identified specification,	including the
I acknowledge the Regulations, § 1.5	e duty to disclose information 66.	which is material to pater	tability as defined in Title	37, Code of Federal
for patent or inver	cign priority benefits under I ntor's certificate listed below atc having a filing date befor	and have also identified be	zlow any foreign applicatio	n for patent or
				Priority Claimed
(List prior foreign applications. See note A)	2003-291220 (Number)		11/August/2003 (Day/Month/Year Filed)	⊠ Yes □ No
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	- -
(See note B) D Se	e attached list for additional	prior foreign applications		
I hereby claim the insofar as the subjin the manner proinformation which § 1.56 which becaudate of this applica	benefit under Title 35, Unite cet matter of each of the clair vided by the first paragraph is material to patentability a me available between the filiation.	ed States Code, § 120 of a ms of this application is no of Title 35, United States s defined in Title 37, Code ing date of the prior applic	ny United States application the disclosed in the prior Unicode, § 112. I acknowledge of Federal Regulations, ation and the national or Position of Po	n(s) listed below and, ited States application to the duty to disclose T international filing
		·	Stat	us
(List prior U.S. Applications)	Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned
(A	мррисацон эсна г No.)	(rining Date)		
	Application Scrial No.)	(Filing Date)	☐ Patented ☐ Pending ☐ Abandoned	
	Application Serial No.)	(Filing Date)	☐ Patented ☐ Pending ☐ Abandoned	
<u></u>	Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned

NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or	first inventor (given name, family name)	Masaaki TOZAWA		
	Inventor's signature	Masaabi TOZAWA	Date January 6, 200		
	Residence	Osaka	Citizenship Japan		
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		3-47, Funamachi 1-choume, Taisho-ku, Osaka-shi, Osaka, 551-0022 Japan			
	Full name of second	inventor (given name, family name)	The state of the s		
	Inventor's signature	Ryosuke SUGIHARA	Date January 6, 2006		
	Residence	Osaka	Citizenship Japan		
	Post Office Address	c/o TAYCA CORPORATION			
÷		3-47, Funamachi 1-choume, Taisho-ku	ı, Osaka-shi, Osaka, 551-0022 Japan		
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₹,	Inventor's signature	ventor (given name, family name)	Date		
u	Residence		Citizenship		
	Post Office Address	· · · · · · · · · · · · · · · · · · ·			
	Full name of fourth in	iventor (given name, family name)			
	Inventor's signature	Control (B. von mann), turning manney	Date		
	Residence		Citizenship		
	Post Office Address				
	Full name of fifth inventor (given name, family name) Inventor's signature Date				
	Residence		Date		
	Post Office Address		Citizenship		
	Full name of sixth inventor (given name, family name) Inventor's signature		Date		
	Residence		Citizenship		
	Post Office Address				